

Vishay Siliconix

COMPLIANT

N-Channel 60-V (D-S) MOSFET

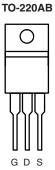
PRODUCT SUMMARY				
V _{(BR)DSS} (V)	r _{DS(on)} (Ω)	I _D (A)	Q _g (Тур)	
60	0.005 at V_{GS} = 10 V	90 ^d	105	

FEATURES

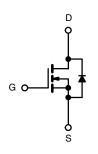
- TrenchFET[®] Power MOSFET
- 175 °C Junction Temperature
- 100 % R_q and UIS Tested

APPLICATIONS

- Power Supply
 - Secondary Synchronous Rectification
- Industrial
- OR-ing



Top View Ordering Information: SUP90N06-5m0P-E3 (Lead (Pb)-free)



N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS	T _C = 25 °C, unless oth	nerwise noted			
Parameter		Symbol	Limit	Unit	
Drain-Source Voltage		V _{DS}	60	V	
Gate-Source Voltage		V _{GS}	± 20		
Continuous Drain Current ($T_J = 175 \ ^{\circ}C$)	T _C = 25 °C	1_	90 ^d	А	
	T _C = 70 °C	I _D	90 ^d		
Pulsed Drain Current		I _{DM}	240		
Avalanche Current		I _{AS}	70		
Single Avalanche Energy ^a	L = 0.1 mH	E _{AS}	245	mJ	
	T _C = 25 °C	Р	300 ^b	w	
Maximum Power Dissipation ^a	T _A = 25 °C ^c	– P _D –	3.75		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 175	°C	

THERMAL RESISTANCE RATINGS				
Parameter	Symbol	Limit	Unit	
Junction-to-Ambient (PCB Mount) ^c	R _{thJA}	40	°C/W	
Junction-to-Case (Drain)	R _{thJC}	0.5	0/10	

Notes:

a. Duty cycle \leq 1 %.

b. See SOA curve for voltage derating.

c. When Mounted on 1" square PCB (FR-4 material).

d. Package limited.

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SUP90N06-5m0P

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SPECIFICATIONS $T_J = 25 \text{ °C}$, unless otherwise noted							
Parameter	Symbol	Test Conditions	Min	Тур	Мах	Unit	
Static				1			
Drain-Source Breakdown Voltage	V _{(BR)DSS}	$V_{DS} = 0 V, I_{D} = 250 \mu A$	60			v	
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$	2.5		4.5		
Gate-Body Leakage	I _{GSS}	V_{DS} = 0 V, V_{GS} = ± 20 V			± 250	nA	
Zero Gate Voltage Drain Current		$V_{DS} = 60 \text{ V}, V_{GS} = 0 \text{ V}$			1	μA	
	I _{DSS}	V_{DS} = 60 V, V_{GS} = 0 V, T_{J} = 125 °C			50		
		$V_{DS} = 60 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 150 \text{ °C}$			250		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 10$ V, $V_{GS} = 10$ V	70			А	
Drain-Source On-State Resistance ^a	r	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 20 \text{ A}$		0.0041	0.005	Ω	
	^r DS(on)	V_{GS} = 10 V, I _D = 20 A, T _J = 125 °C		0.0068	0.0087		
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 20 A		60		S	
Dynamic ^b							
Input Capacitance	C _{iss}			6190		pF	
Output Capacitance	C _{oss}	V _{GS} = 0 V, V _{DS} = 30 V, f = 1 MHz		990			
Reverse Transfer Capacitance	C _{rss}			340			
Total Gate Charge ^c	Qg			105	160	nC	
Gate-Source Charge ^c	Q _{gs}	$V_{DS} = 30$ V, $V_{GS} = 10$ V, $I_{D} = 85$ A		29			
Gate-Drain Charge ^c	Q _{gd}			28			
Gate Resistance	R _g	f = 1 MHz		1.4	2.8	Ω	
Turn-On Delay Time ^c	t _{d(on)}			23	35		
Rise Time ^c	t _r	V_{DD} = 30 V, R_L = 0.4 Ω		15	25	ns	
Turn-Off Delay Time ^c	t _{d(off)}	$I_D \cong 85 \text{ A}, \text{ V}_{\text{GEN}} = 10 \text{ V}, \text{ R}_{\text{g}} = 1 \Omega$		36	55		
Fall Time ^c	t _f			8	15		
Source-Drain Diode Ratings and Cha	aracteristics	(T _C = 25 °C) ^b					
Continuous Current	ا _S				85	— A	
Pulsed Current	I _{SM}				240		
Forward Voltage ^a	V _{SD}	I _F = 30 A, V _{GS} = 0 V		0.84	1.5	V	
Reverse Recovery Time	t _{rr}			61	100	ns	
Peak Reverse Recovery Current	I _{RM(REC)}	I _F = 75 A, di/dt = 100 A/μs		3.0	4.5	А	
Reverse Recovery Charge	Q _{rr}			91	140	μC	

Notes:

a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %.

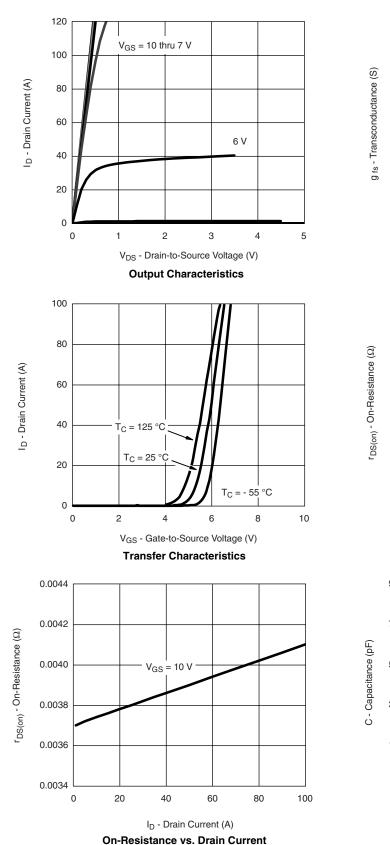
b. Guaranteed by design, not subject to production testing.

c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

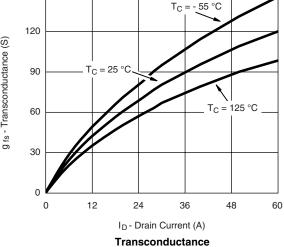
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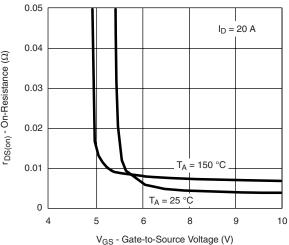


TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

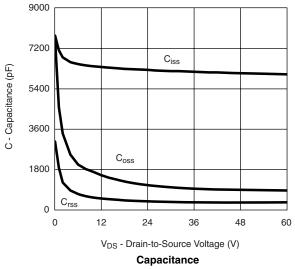
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150



On-resistance vs. Gate-to-Source Voltage

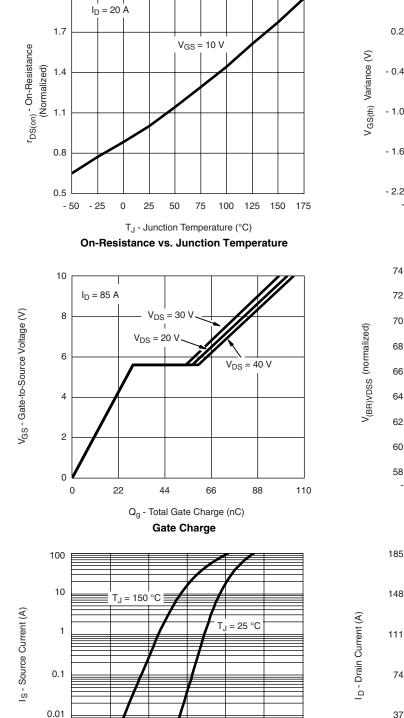


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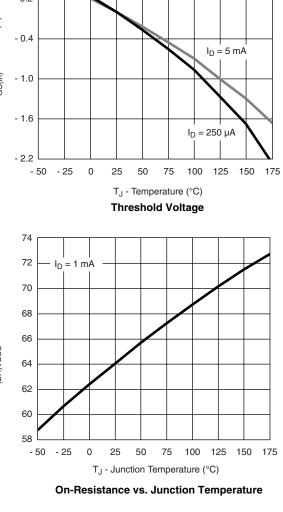
2.0

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



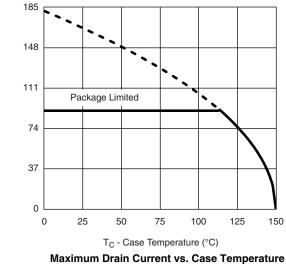
1.0

1.2



0.8

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0.001

0

0.2

0.4

0.6

V_{SD} - Source-to-Drain Voltage (V)

Source-Drain Diode Forward Voltage

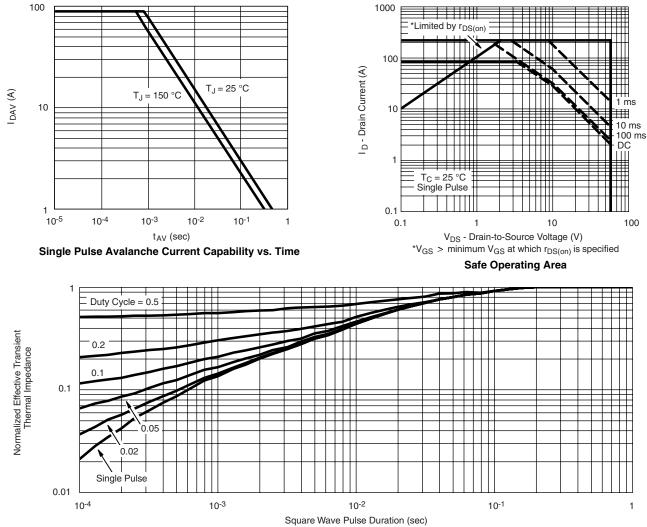
0.8

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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

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Normalized Thermal Transient Impedance, Junction-to-Case

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see http://www.vishay.com/ppg?74641.



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